

Molding Type Module IGBT, 1-in-1 Package, 1200 V and 300 A



Dual INT-A-PAK

PRIMARY CHARACTERISTICS						
V _{CES}	1200 V					
I _C at T _C = 80 °C	300 A					
V _{CE(on)} (typical) at I _C = 300 A, 25 °C	1.90 V					
Speed	8 kHz to 30 kHz					
Package	Dual INT-A-PAK					
Circuit configuration	Single switch with AP diode					

FEATURES

- High short circuit capability, self limiting to 6 x I_C
- 10 µs short circuit capability



- V_{CE(on)} with positive temperature coefficient
- Low inductance case
- · Fast and soft reverse recovery antiparallel FWD
- Isolated copper baseplate using DCB (Direct Copper Bonding) technology
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- Switching mode power supplies
- · AC inverter drives
- Electronic welders at f_{sw} up to 20 kHz

DESCRIPTION

Vishay's IGBT power module provides ultralow conduction loss as well as short circuit ruggedness. It is designed for applications such as general inverters and UPS.

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		1200	V	
Gate to emitter voltage	V_{GES}		± 20	V	
Collector current at T _{.I} = 150 °C		T _C = 25 °C	620		
Collector current at 1 _J = 150°C	I _C	T _C = 80 °C	300		
Pulsed collector current	I _{CM} ⁽¹⁾	T _C = 80 °C	600	Α	
Diode continuous forward current	I _F		300		
Diode maximum forward current	I _{FM}		600		
Maximum power dissipation	P _D	T _J = 150 °C	2500	W	
Short circuit withstand time	t _{SC}	T _J = 125 °C	10	μs	
l ² t-value, diode	l ² t	$V_R = 0 \text{ V}, \text{ t} = 10 \text{ ms}, T_J = 125 ^{\circ}\text{C}$	19 000	A ² s	
RMS isolation voltage	V _{ISOL}	f = 50 Hz, t = 1 min	2500	V	

Note

⁽¹⁾ Repetitive rating: pulse width limited by maximum junction temperature

IGBT ELECTRICAL SPECIFICATIONS (T _C = 25 °C unless otherwise noted)						
						UNITS
Collector to emitter breakdown voltage	V _{(BR)CES}	T _J = 25 °C	1200	-	-	
Outlined and a sufficient of the sufficient		V _{GE} = 15 V, I _C = 300 A, T _J = 25 °C	-	1.9	-	1 ,,
Collector to emitter saturation voltage	V _{CE(on)}	V _{GE} = 15 V, I _C = 300 A, T _J = 125 °C	-	2.1	-	V
Gate to emitter threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}, I_{C} = 12 \text{ mA}, T_{J} = 25 \text{ °C}$	5	6.2	7.0	
Zero gate voltage collector current	I _{CES}	$V_{CE} = V_{CES}$, $V_{GE} = 0$ V, $T_{J} = 25$ °C	-	-	5.0	mA
Gate to emitter leakage current	I _{GES}	$V_{GE} = V_{GES}$, $V_{CE} = 0$ V, $T_{J} = 25$ °C	-	-	400	nA



SWITCHING CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-on delay time	t _{d(on)}		-	90	-	
Rise time	t _r		-	55	-	ns
Turn-off delay time	t _{d(off)}	$V_{CC} = 600 \text{ V}, I_{C} = 300 \text{ A}, R_{g} = 4.7 \Omega,$	-	460	-	
Fall time	t _f	$V_{GE} = \pm 15 \text{ V}, T_{J} = 25 \text{ °C}$	-	55	-	
Turn-on switching loss	E _{on}		-	28	-	- mJ
Turn-off switching loss	E _{off}		-	25	-	1110
Turn-on delay time	t _{d(on)}		-	110	-	
Rise time	t _r		-	60	-	ns
Turn-off delay time	t _{d(off)}	$V_{CC} = 600 \text{ V}, I_{C} = 300 \text{ A}, R_{g} = 4.7 \Omega,$	-	500	-	
Fall time	t _f	$V_{GE} = \pm 15 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	-	60	-	
Turn-on switching loss	E _{on}		-	31	-	mJ
Turn-off switching loss	E _{off}		-	27	-	1110
Input capacitance	C _{ies}		-	21	-	
Output capacitance	C _{oes}	$V_{GE} = 0 \text{ V}, V_{CE} = 25 \text{ V}, f = 1.0 \text{ MHz}$	-	1.5	-	nF
Reverse transfer capacitance	C _{res}		-	0.9	-	
SC data	I _{SC}	$t_{SC} \leq 10 \; \mu \text{s, V}_{GE} = 15 \; \text{V, T}_{J} = 125 \; ^{\circ}\text{C,}$ $V_{CC} = 900 \; \text{V, V}_{CEM} \leq 1200 \; \text{V}$	-	1300	-	Α
Stray inductance	L _{CE}		-	-	20	nH
Module lead resistance, terminal to chip	R _{CC'+EE'}	T _C = 25 °C	-	0.18	-	mΩ

DIODE ELECTRICAL SPECIFICATIONS (T _C = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Diode forward voltage	V	I _F = 300 A	T _J = 25 °C	-	2.0	2.4	V
Diode forward voltage	V _F		T _J = 125 °C	-	2.2	2.5	
Die de verrage vereniew, chaves	0	Q_{rr} $I_F = 300 \text{ A}, V_R = 600 \text{ V},$ $dI/dt = -2400 \text{ A}/\mu\text{s},$ $V_{GF} = -15 \text{ V}$	T _J = 25 °C	-	27	-	
Diode reverse recovery charge	Q _{rr}		T _J = 125 °C	-	50	-	μC
Diode peak reverse recovery current	1		T _J = 25 °C	-	120	-	^
blode peak reverse recovery current	¹rr		T _J = 125 °C	-	170	-	Α
Diada rayaraa raaayany anaray		GE	T _J = 25 °C	-	9	-	ml
Diode reverse recovery energy	E _{rec}		T _J = 125 °C	-	20	-	mJ

THERMAL AND MECHANICAL SPECIFICATIONS								
PARAMETER		SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Operating junction temperature	re range	TJ		-40	-	150	°C	
Storage temperature range		T _{Stg}		-40	-	125		
Junction to case	IGBT	D		-	-	0.05		
per module	Diode	R_{thJC}		-	-	0.12	K/W	
Case to sink		R _{thCS}	Conductive grease applied	-	0.035	-		
Mounting torque			Power terminal screw: M6	2.5 to 5.0)	Nm	
Mounting torque			Mounting screw: M6	3.0 to 6.0		INIII		
Weight				310		g		



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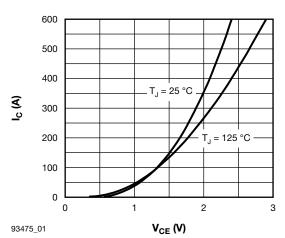


Fig. 1 - Typical Output Characteristics $V_{GE} = 15 \text{ V}$

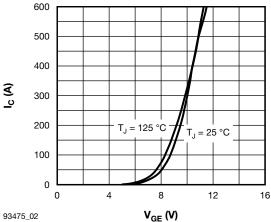


Fig. 2 - Typical Transfer Characteristics $V_{\text{CE}} = 20 \text{ V}$

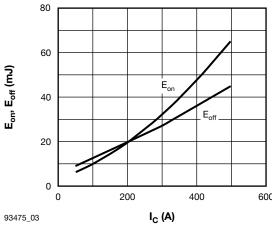


Fig. 3 - Switching Loss vs. Collector Current V_{CC} = 600 V, R_g = 4.7 Ω , V_{GE} = \pm 15 V, T_J = 125 °C

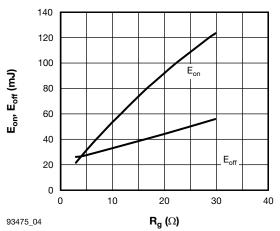


Fig. 4 - Switching Loss vs. Gate Resistor V_{CC} = 600 V, I_{C} = 300 A, V_{GE} = \pm 15 V, T_{J} = 125 $^{\circ}C$

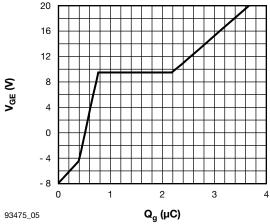


Fig. 5 - Gate Charge Characteristics $V_{CC} = 600 \text{ V}, I_C = 300 \text{ A}, T_J = 25 ^{\circ}\text{C}$

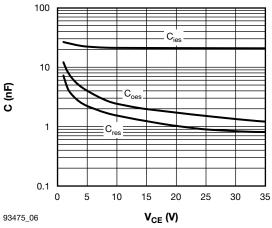


Fig. 6 - Typical Capacitance vs. Collector to Emitter Voltage

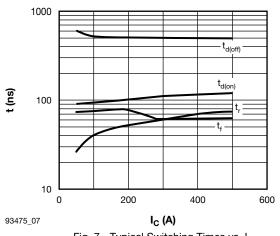


Fig. 7 - Typical Switching Times vs. I_C V_{CC} = 600 V, R_g = 4.7 Ω , V_{GE} = \pm 15 V, T_J = 125 °C

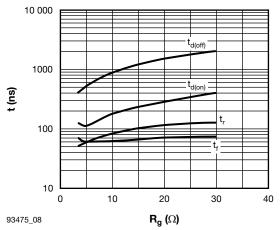


Fig. 8 - Typical Switching Times vs. Gate Resistance V_{CC} = 600 V, I_{C} = 300 A, V_{GE} = ± 15 V, T_{J} = 125 °C

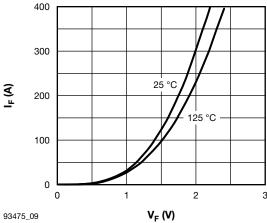


Fig. 9 - Typical Forward Characteristics (Diode)

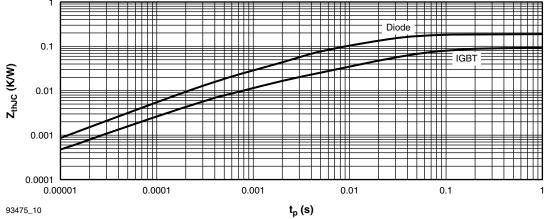
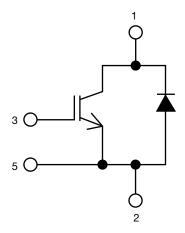


Fig. 10 - Transient Thermal Impedance



CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95526			



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